

# HSF

**NOTES:**

Current Rating: 1.0AMP  
 Contact Resistance: 20mΩ Max  
 Withstand Voltage: 500V AC/DC  
 Insulation Resistance: 1000MΩ Min  
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze  
 Contact plating: Au or Sn over Ni  
 Insulator Material: PA9T+33%GF UL94V-0

## Ordering Information

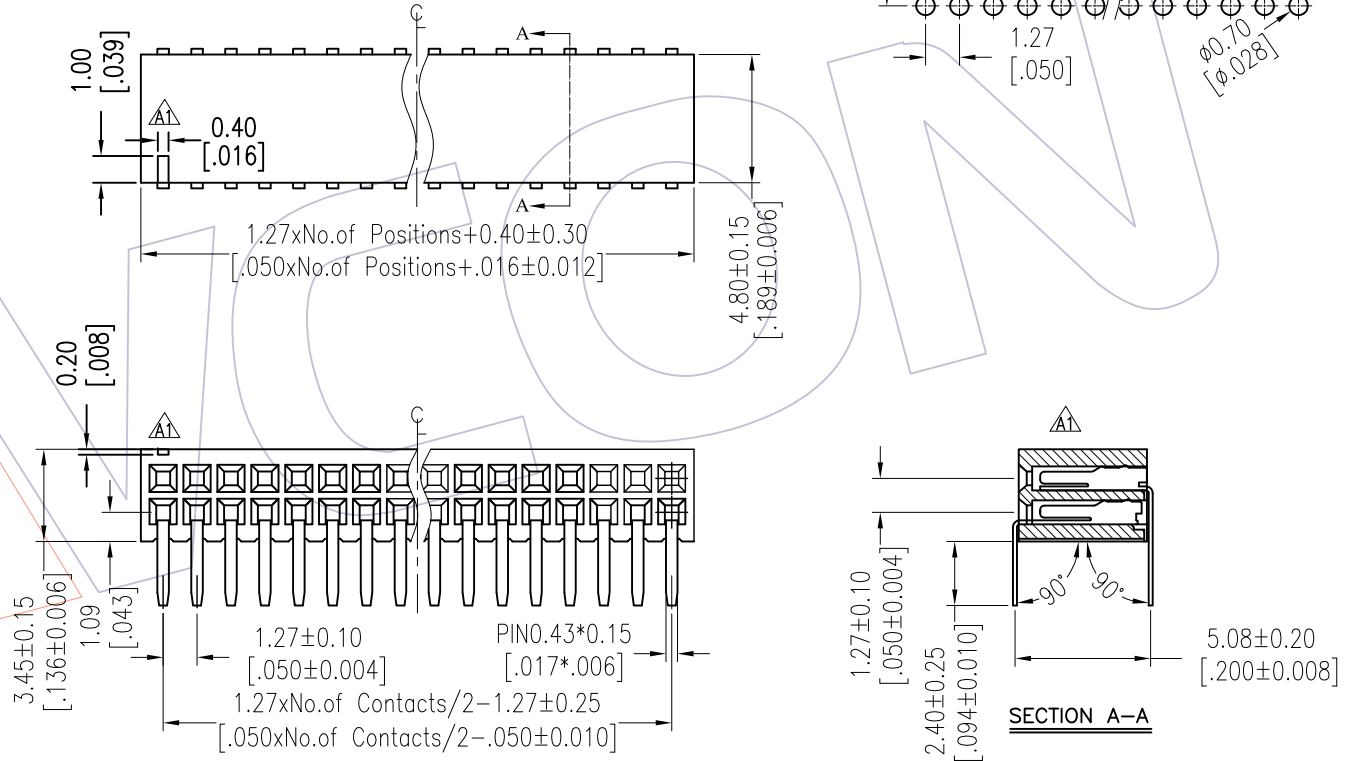
2335-2 XX R XX CUN X 1

No. of Pins per Row: 02-50Pin

Contact Plating:  
 G0=Gold Flash  
 G3=10μ"Gold  
 G4=15μ"Gold  
 G5=30μ"Gold  
 S0=Gold Flash/Tin  
 S3=10μ"Gold/Tin  
 S4=15μ"Gold/Tin  
 S5=30μ"Gold/Tin  
 SN=Tin

Packing:  
 T=Tube  
 R=Tape&Reel

Recommended P.C.B Layout (Top Side)  
 (PCB BOARD TOLERANCE ±0.05)



Item	Pitch	Mating
Standard	1.27	1310/1315/1320
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
				X.X ±0.40	Surong Xu	2017/04/19	UNIT	mm	2335-2XXRXXCUNX1
A1	2017/04/19	Modify plasitc, Add Tape Packing	△	X.XX ±0.25	CHECK	DATE	SIZE	A4	TITLE: FH1.27 DUAL SIDE INSERT 90° H=3.45
A0	2012/07/07	NEW	-----	X.XXX ±0.15	APPROVE	DATE	SHEET	1/1	Customer NO.
				Angle ± 3'			PROJ.		
				DIM TOL					

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